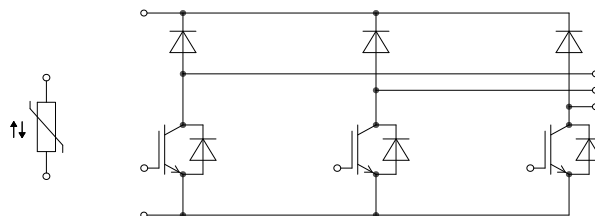
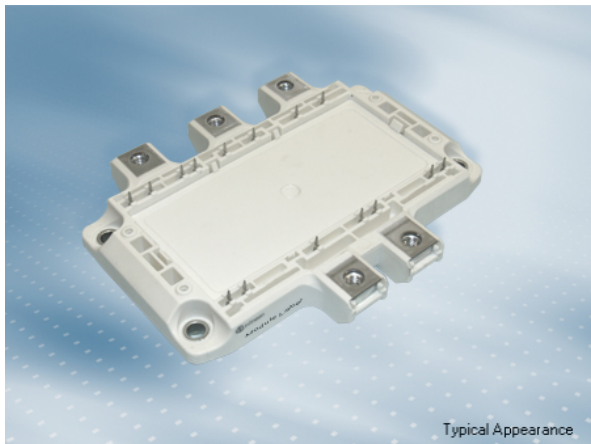




EconoPACK™4 Modul mit Trench/Feldstopp IGBT4 und Emitter Controlled Diode und NTC  
EconoPACK™4 module with trench/fieldstop IGBT4 and Emitter Controlled Diode and NTC



$V_{CES} = 650V$   
 $I_{C\ nom} = 400A / I_{CRM} = 800A$

**Typische Anwendungen**

- Chopper-Anwendungen
- Motorantriebe
- Solar Anwendungen
- USV-Systeme

**Typical Applications**

- Chopper Applications
- Motor Drives
- Solar Applications
- UPS Systems

**Elektrische Eigenschaften**

- Erhöhte Sperrspannungsfestigkeit auf 650V
- Erweiterte Sperrschichttemperatur  $T_{vj\ op}$
- Trench IGBT 4
- $T_{vj\ op} = 150^{\circ}C$
- $V_{CESat}$  mit positivem Temperaturkoeffizienten

**Electrical Features**

- Increased blocking voltage capability to 650V
- Extended Operation Temperature  $T_{vj\ op}$
- Trench IGBT 4
- $T_{vj\ op} = 150^{\circ}C$
- $V_{CESat}$  with positive Temperature Coefficient

**Mechanische Eigenschaften**

- 2,5 kV AC 1min Isolationsfestigkeit
- Hohe mechanische Robustheit
- Integrierter NTC Temperatur Sensor
- Isolierte Bodenplatte
- Standardgehäuse

**Mechanical Features**

- 2.5 kV AC 1min Insulation
- High mechanical robustness
- Integrated NTC temperature sensor
- Isolated Base Plate
- Standard Housing

**Module Label Code**

Barcode Code 128



DMX - Code



**Content of the Code**

Content of the Code	Digit
Module Serial Number	1 - 5
Module Material Number	6 - 11
Production Order Number	12 - 19
Datecode (Production Year)	20 - 21
Datecode (Production Week)	22 - 23

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approved by: MK	revision: 3.0	UL approved (E83335)



**IGBT, Brems-Chopper / IGBT, Brake-Chopper**  
**Höchstzulässige Werte / Maximum Rated Values**

Kollektor-Emitter-Sperrspannung Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{CES}$	650	V
Kollektor-Dauergleichstrom Continuous DC collector current	$T_C = 55^{\circ}\text{C}, T_{vj\text{max}} = 175^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}, T_{vj\text{max}} = 175^{\circ}\text{C}$	$I_{C\text{nom}}$ $I_C$	400 460	A A
Grenzeffektivstrom der Modul Kontakte Maximum RMS module terminal current	$T_{Ct} = 90^{\circ}\text{C}$ $T_{Ct} = 50^{\circ}\text{C}$	$I_{RMS}$	240 300	A
Periodischer Kollektor-Spitzenstrom Repetitive peak collector current	$t_p = 1\text{ms}$	$I_{CRM}$	800	A
Gesamt-Verlustleistung Total power dissipation	$T_C = 25^{\circ}\text{C}, T_{vj\text{max}} = 175^{\circ}\text{C}$	$P_{tot}$	1150	W
Gate-Emitter-Spitzenspannung Gate-emitter peak voltage		$V_{GES}$	+/-20	V

**Charakteristische Werte / Characteristic Values**

			min.	typ.	max.		
Kollektor-Emitter-Sättigungsspannung Collector-emitter saturation voltage	$I_C = 400\text{A}, V_{GE} = 15\text{V}$ $I_C = 400\text{A}, V_{GE} = 15\text{V}$ $I_C = 400\text{A}, V_{GE} = 15\text{V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$V_{CE\text{sat}}$	1,55 1,70 1,75	1,95	V V V	
Gate-Schwellenspannung Gate threshold voltage	$I_C = 4,80\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$		$V_{G\text{Eth}}$	5,1	5,8	6,4	V
Gateladung Gate charge	$V_{GE} = -15\text{V} \dots +15\text{V}$		$Q_G$	4,30			$\mu\text{C}$
Interner Gatewiderstand Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$		$R_{G\text{int}}$	1,0			$\Omega$
Eingangskapazität Input capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$		$C_{ies}$	18,5			nF
Rückwirkungskapazität Reverse transfer capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$		$C_{res}$	0,55			nF
Kollektor-Emitter-Reststrom Collector-emitter cut-off current	$V_{CE} = 650\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^{\circ}\text{C}$		$I_{CES}$			0,02	mA
Gate-Emitter-Reststrom Gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^{\circ}\text{C}$		$I_{GES}$			400	nA
Einschaltverzögerungszeit, induktive Last Turn-on delay time, inductive load	$I_C = 400\text{A}, V_{CE} = 300\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Gon} = 1,6\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$t_{d\text{on}}$	0,10 0,11 0,115			$\mu\text{s}$ $\mu\text{s}$ $\mu\text{s}$
Anstiegszeit, induktive Last Rise time, inductive load	$I_C = 400\text{A}, V_{CE} = 300\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Gon} = 1,6\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$t_r$	0,085 0,094 0,095			$\mu\text{s}$ $\mu\text{s}$ $\mu\text{s}$
Abschaltverzögerungszeit, induktive Last Turn-off delay time, inductive load	$I_C = 400\text{A}, V_{CE} = 300\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 1,6\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$t_{d\text{off}}$	0,455 0,48 0,495			$\mu\text{s}$ $\mu\text{s}$ $\mu\text{s}$
Fallzeit, induktive Last Fall time, inductive load	$I_C = 400\text{A}, V_{CE} = 300\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 1,6\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$t_f$	0,069 0,097 0,10			$\mu\text{s}$ $\mu\text{s}$ $\mu\text{s}$
Einschaltverlustenergie pro Puls Turn-on energy loss per pulse	$I_C = 400\text{A}, V_{CE} = 300\text{V}, L_S = 30\text{nH}$ $V_{GE} = \pm 15\text{V}, di/dt = 4200\text{A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $R_{Gon} = 1,6\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$E_{on}$	5,50 7,95 8,25			mJ mJ mJ
Abschaltverlustenergie pro Puls Turn-off energy loss per pulse	$I_C = 400\text{A}, V_{CE} = 300\text{V}, L_S = 30\text{nH}$ $V_{GE} = \pm 15\text{V}, du/dt = 2600\text{V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $R_{Goff} = 1,6\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$E_{off}$	20,0 24,0 25,0			mJ mJ mJ
Kurzschlußverhalten SC data	$V_{GE} \leq 15\text{V}, V_{CC} = 360\text{V}$ $V_{CE\text{max}} = V_{CES} - L_{SCE} \cdot di/dt$ $t_p \leq 10\mu\text{s}, T_{vj} = 150^{\circ}\text{C}$		$I_{SC}$	1500			A
Wärmewiderstand, Chip bis Gehäuse Thermal resistance, junction to case	pro IGBT / per IGBT		$R_{thJC}$			0,13	K/W

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